

Thermal CPU Paste Compound for Heatsink

StarTech ID: HEATGREASE



This thermal CPU paste can be used to improve the effectiveness of a CPU cooler by thermally bonding the CPU to the heatsink, allowing the heatsink and fan to work at their full capacity to remove the harmful heat away from the CPU.

Applications

- Replace old or dried out thermal paste
- Add thermal compound to a new system build for the CPU

Features

- Ceramic-based compound containing silicone
- Thermal conductivity of more than 1.066 W/m-K

Technical Specifications

Warranty	2 Years
Shipping (Package) Weight	0 lb [0 kg]
Included in Package	1 - Thermal Compound

Certifications, Reports and Compatibility

